

RELIABILITY REPORT

FOR

MAX253

PLASTIC ENCAPSULATED DEVICES

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MAXIM INTEGRATED

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Conclusion

The MAX253 successfully meets the quality and reliability standards required of all Maxim products. In addition, Maxim's continuous reliability monitoring program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards.

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I. Device Description

A. General

The MAX253 monolithic oscillator/power-driver is specifically designed to provide isolated power for an isolated RS-485 or RS-232 data interface. The device drives a center-tapped transformer primary from a 5V or 3.3V DC power supply. The secondary can be wound to provide any isolated voltage needed at power levels up to 1W. The MAX253 consists of a CMOS oscillator driving a pair of N-channel power switches. The oscillator runs at double the output frequency, driving a toggle flip-flop to ensure 50% duty cycle to each of the switches. Internal delays are arranged to ensure break-before-make action between the two switches. The SD pin puts the entire device into a low-power shutdown state, disabling both the power switches and oscillator.



II. Manufacturing Information

A. Description/Function: 1W Primary-Side Transformer H-Bridge Driver for Isolated Supplies

B. Process: M5C. Fabrication Location: USA

D. Assembly Location: Malaysia, Philippines, Thailand

E. Date of Initial Production: Pre 1997

III. Packaging Information

A. Package Type: 8-pin SOIC (N)
B. Lead Frame: Copper

C. Lead Finish:

D. Die Attach:
Conductive

E. Bondwire:
Au (1.3 mil dia.)

F. Mold Material:
Epoxy with silica filler

G. Assembly Diagram:
#05-1901-0044

H. Flammability Rating:
Class UL94-V0

I. Classification of Moisture Sensitivity

per JEDEC standard J-STD-020-C

J. Single Layer Theta Ja: 170°C/W
K. Single Layer Theta Jc: 40°C/W
L. Multi Layer Theta Ja: 132°C/W
M. Multi Layer Theta Jc: 38°C/W

IV. Die Information

A. Dimensions: 58 X 85 mils

B. Passivation: Si₃N₄/SiO₂ (Silicon nitride/ Silicon dioxide)

C. Interconnect: Al/1.0%SiD. Backside Metallization: None

E. Minimum Metal Width: Metal1 = 0.5 / Metal2 = 0.6 / Metal3 = 0.6 microns (as drawn)
 F. Minimum Metal Spacing: Metal1 = 0.45 / Metal2 = 0.5 / Metal3 = 0.6 microns (as drawn)

Level 1

G. Bondpad Dimensions: 5 mil. Sq.
 H. Isolation Dielectric: SiO₂
 I. Die Separation Method: Wafer Saw



V. Quality Assurance Information

Eric Wright (Reliability Engineering) A. Quality Assurance Contacts:

Brian Standley (Manager, Reliability) Bryan Preeshl (Vice President of QA)

B. Outgoing Inspection Level: 0.1% for all electrical parameters guaranteed by the Datasheet.

0.1% for all Visual Defects.

C. Observed Outgoing Defect Rate: < 50 ppm D. Sampling Plan: Mil-Std-105D

VI. Reliability Evaluation

A. Accelerated Life Test

The results of the 135°C biased (static) life test are shown in Table 1. Using these results, the Failure Rate (3.) is calculated as follows:

$$\lambda = 5.5 \times 10^{-9}$$

 $\lambda = 5.5 \text{ F.I.T. (60\% confidence level @ 25°C)}$

The following failure rate represents data collected from Maxim's reliability monitor program. Maxim performs quarterly life test monitors on its processes. This data is published in the Reliability Report found at http://www.maxim-ic.com/qa/reliability/monitor. Cumulative monitor data for the M5 Process results in a FIT Rate of 0.34 @ 25C and 5.79 @ 55C (0.8 eV, 60% UCL)

B. E.S.D. and Latch-Up Testing

The RS19 die type has been found to have all pins able to withstand a transient pulse of:

ESD-HBM: +/- 2500V per JEDEC JESD22-A114 ESD-CDM: +/- 750V per JEDEC JESD22-C101

Latch-Up testing has shown that this device withstands a current of +/-100mA and overvoltage per JEDEC JESD78.



Table 1Reliability Evaluation Test Results

MAX253

TEST ITEM	TEST CONDITION	FAILURE IDENTIFICATION	SAMPLE SIZE	NUMBER OF FAILURES	COMMENTS
Static Life Test (Not	e 1) Ta = 135°C Biased Time = 192 hrs.	DC Parameters & functionality	200	0	

Note 1: Life Test Data may represent plastic DIP qualification lots.